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4-BIT SINGLE CHIP MICROCOMPUTERS

ADAM43P1108 USER`S MANUAL

0. Revision History

The ADAM43P1108 is the High Speed and Low Voltage operating 4-bit single chip microcomputer. This chip contains ADAM43 CPU, EPROM, RAM, Timer/PWM, Interrupt, Watch Dog Timer, 12-bit ADC, Input/Output Ports and Oscillation Circuit.

1.1. Features

- ◆ Instruction Execution Time
	- 500ns @ fosc=8MHz
- ◆ Program Memory Area (MTP)
	- \bullet 4K Bytes (2,048 x 16bit)
		- Multi-programmable by 2K Bytes(1,024 x 16bit)
- ◆ Data memory (RAM)
	- \bullet 128 nibble (128 x 4bit)
- 16-Bit Table read Instruction.
- ◆ A/D Converter
	- \bullet 12Bit x 5ch
- ◆ Timer (Timer/Counter/Capture/PWM)
	- \bullet 12Bit x 1ch [PWM0 : $(8+4)$ bit x 1ch]
	- 8Bit x 1ch $[PWM1:(6+2)bitx 1ch]$
- ◆ Watch-Dog Timer (with RCWDT=64kHz)
	- \bullet 19Bit x 1ch
- ◆ Oscillator Type
	- \bullet Calibrated Internal RCOSC : typ. 16/8/4/1MHz(\pm 2%) selectable
	- \bullet External R-OSC : 400k~16MHz
	- External Clock Input : $400k \sim 16MHz$
	- \bullet Crystal/Resonator : 400k ~ 16MHz, 32.768kHz
- ◆ Power On Reset
- ◆ Power Saving Operation Modes
	- STOP
	- SLEEP
	- RCWDT
- ◆ Interrupt Sources
	- External : 3ch (KSCN, INT0, INT1)
	- Internal : 5ch (T0, T1, ADC, WDT, VDI)
	- ◆ Low Voltage Detection Reset Circuit
- ◆ 3-level Voltage Detection Indicator (4.0V/3.0V/2.5V)
- ◆ Operating Voltage Range
	- 2.0 \sim 5.5 V @ 30kHz \sim 4MHz
		- 2.7 \sim 5.5 V @ 4MHz \sim 16MHz
- ◆ Operating Temperature Range
	- $-40 \sim 85$ °C
- ADAM43P1108 Device Summary

1.4. Package Dimension

8 SOP (150Mil) Pin Dimension (dimensions in millimeters)

8 DIP (300Mil) Pin Dimension (dimensions in millimeters)

8 TSSOP (4.4 mm) Pin Dimension (dimensions in inch [millimeters])

1.5. Pin Function

1.5.1. Port Pins

1.5.2. Non-port Pins

1.5.3. OTP Programming Pin Description (OTP Program Mode)

1.6. Port Structure

** : It is depend on user definition.

1.6. Port Structure

* : It is depend on user definition.

1.6. Port Structure

* : It is depend on user definition.

1.6. Port Structure

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1.6. Port Structure (OSC1/OSC2 mode)

1.7. Electrical Characteristics

1.7.2. Recommended Operating Ranges

1.7.3. POR(Power on Reset) Electrical Characteristics (VDD=5.5V~2.0V, VSS=0V, Ta = -40℃~85℃)

*) These parameters are presented for design guidance only and not tested or guaranteed.

1.7.4. DC Characteristics (Ta = 25℃)

※ Typical Characteristics

This graphs provided in this section are for design guidance only and are not tested or guaranteed.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean $+$ 3σ) and (mean $-$ 3σ) respectively where σ is standard deviation.

▶ **IOL1 vs. VOL1 (at T=25**℃**)**

1 1.5 2 2.5 3 3.5 4

2 3 4 5 6

▶ Internal RC Oscillator Characteristics

▶ Low Voltage Detection (Temperature Characteristics)

1.7.5. 12Bit A/D Conversion Characteristics (VDD=5.5 ~ 2.7V @fxIN=30kHz~16MHz, Ta=25℃)

1.7.6. AC Characteristics (Ta = 25℃)

Minimum pulse width

2.1. Program Memory

The ADAM43P1108 can address maximum 4Kbytes (2K words \times 16bits) for program memory. Program counter PC ($A0~\sim A10$) is used to address the whole area of program memory having an instruction (16bits) to be next executed.

The program memory consists of 2K words.

The program memory is composed as shown below.

Fig.2.1 Configuration of Program Memory

2.2. Address Register

The following registers are used to address the ROM.

- **Program counter (PC) :** Available for addressing word on each page.
- **Stack register (SR) :** Stores returned-word address in the subroutine call mode.

2.2.1 Program counter :

This 11-bit binary counter increments for fetching a word to be addressed in the currently addressed page having an instruction to be next executed. For easier programming, at turning on the power, the program counter is reset to the zero location(0000H). Then the program counter specifies the next address. When BR, CAL or RET instructions are decoded, the switches on each step are turned off not to update the address. Then, for BR or CAL, address data are taken in from the instruction operands (A0 to A10), or for RET, and address including page address is fetched from stack register No. 1.

2.2.2. Stack register (SR)

The address stack register (ADS) stores a return address when the subroutine call instruction is executed or interrupt is acknowledged.

If subroutine or interrupts are nested to more than 8 levels, internal reset is occurred. The interrupt stack register(INTSK) saves the contents of Status Flag Register (SFR) when an interrupt is acknowledged.

The saved contents are restored when an interrupt return(RETI) instruction is executed. INTSK saves data each time an interrupt is acknowledged.

The programmer must keep in mind that the level of INTSK is 8. So, if more over 8 levels of interrupt occur, the first stored data is lost. There is different result between Stack overflow and interrupt stack overflow.

When clearing SP (Stack Pointer) with using "SPC" instruction, interrupt processing must be inhibited before "SPC".

2.3. Data Memory (RAM)

128 nibbles (128 words \times 4bits) is incorporated for storing data.

Fig.2.2 Data Memory

2.3.1. Data memory(RAM) addressing method

The whole data memory area is directly addressed by 8-bit ram data address point (dp).

Index data memory addressing is available using X-register and Y-register. In this case, X-register is added upper 4bit of data point and Y-register is added lower 4bit of data point.

2.3.2. Data memory(RAM) data addressing example Program

Program Example)

LDM MEM0,#3h LYI #7
LXI #1 lxi
Lda MEM0 EIX LDM MEM0,A DIX

Result after executing ; MEM0 = 3h $MEM0 + X + Y = 3h$

2.4. General Function Registers

2.4.1. X-register (X)

X-register is consist of 4bit, X-register is used for data memory indexing register.

2.4.2. Y-register (Y)

Y-register is consist of 4 bits. It can used for a general-purpose register. Y-register also used for data memory indexing register.

2.4.3. Accumulator (ACC)

The 4-bit register for holding data and calculation results.

2.4.4. Peripheral Address Register(PAR)

The 6-bit address register for addressing peripheral registers including address buff register(ABR) , data buff register (DBR).

2.4.5. Address Buff Register (ABR)

The 16-bit register for address buffer.

The address of Address Buffer Register (ABR) is 38h \sim 3Bh on the peripheral register. It is composed by 4 registers (ABR0, ABR1, ABR2, ABR3) and each register is 4 bit.

2.5. Buffer Registers (DBR, ABR)

Buffer registers are two types of 16 bit registers composed of 4-ninbble registers. One is Data Buffer Register (DBR) and the other is Address Buffer Register (ABR).

The address of Data Buffer Register (DBR) is 3Ch \sim 3Fh and the address of Address Buffer Register (ABR) is 38h \sim 3Bh on the peripheral register.

These buffers are mainly used for Data transferring between ROM and buffer or peripheral registers and buffer. They are also used for general purpose register for data manipulation, data storage and intermediate buffer.

2.5.1. Function of Address Buff Register (ABR)

The most important function of ABR is ROM address pointer. ABR must be used for reading data from ROM. The data pointed by ABR is read to DBR. ABR value is varied through peripheral control instruction and "INC ABR".

2.5.2. Function of Data Buff Register(DBR)

The most important function of DBR is intermediate (window) buffer for transferring data between peripheral registers and reading data from ROM.

When the data of ROM is read by "LDW @ABR", one word of ROM is fetched to DBR. The MSB of ROM data is written to DBR3 and LSB to DBR0.

If the data of pointed ROM is 1234h, each DBR has the data as DBR0 = 4h, DBR1 = 3h, $DBR2 = 2h$ and $DBR3 = 1h$.

DBR is also used for reading some peripheral register data by 12bit unit or 8bit unit. The peripheral registers are T0CR and T1CR.

Note) HEX. File maps the data as big endian type. Be careful to read the ROM data. When the programmer assigns the data like below, the ROM data is mapped as below. DB 12h, 34h \rightarrow ROM data = 1234h

Fig.2.4 The internal Data flow among DBR, ABR registers and ROM

2.6. Status Flag Registers (SFR)

Status Flag Register (SFR) consists of 4-bit register.

Each of the flags show the post state of operation and the flags determining the CPU operation, initialized as 0h in reset state.

When an interrupt is occurred, the value of SFR keep the value of pre-interrupt except for I flag. So, be careful to initialize the SFR status for getting reliable result in Interrupt sub-routine.

2.6.1 Carry flag (C)

- Carry flag bit is set when there is carry or borrow After executing ADDC / SUBC / ARRC/ARLC instructions.

- Set by SETC and clear by CLRC.
- Load from the assigned bit of Peripheral Registers by LDC
- Transfer to the assigned bit of Peripheral Registers by STC

2.6.2 Index flag (D)

- The control bit of ram data address point indexed or not.
- X-register and Y-register is used for index addressing.
- Set and cleared by EIX, DIX.
- 2.6.3 Interrupt enable flag (I)
	- Master enable flag of interrupt.
	- Set and cleared by EI, DI
	- This Flag immediately becomes "0" when an interrupt is served.

2.6.4 Status flag (S)

- According to the condition after executing an instruction , set or clear.
- Can not be set or clear by any instruction.
- This Flag decides whether operation of BR and CALL would be done or not.

2.7. Peripheral Registers

Note1> * Using the bit access Instruction, bit is read-modified operation (SETR1/CLRR1/STC Instructions)

Note1> '-' is reserved bit , it must be read to "0".

The ADAM43 has 6 I/O ports which are PA (3 I/O), PB (3 I/O).

PA and PB Port have Stop Release selection register.

Pull-up resistor of PA and PB ports can be selectable by program.

Pull-down resistor of PB2 and PB3 ports can be selectable by program.

PA and PB ports contains data direction register which controls I/O and data register which stores port data.

PA, PB2 and PB3 Ports have Open Drain selection register and Data register.

*PB1 is Open Drain output only.

I/O Ports Registers

3.1. Port PA

3.1.1. PA Data Register (PA)

PA data register (PA) is 4-bit register to store data of port PA. When set as the output state by PA, and data is written in PA, data is outputted into PA pin. When set as the input state, input state of pin is read. The initial value of PA is "Fh" in reset state. At output state, if port PA is read, PA Data Register is read instead of port PA.

3.1.2. PA Pull-up Resistor Control Register (PAPU)

PA pull-up resistor control register (PAPU) is 4-bit register and can control pull-up on or off each bit, if corresponding port is selected as input. If PAPU is selected as "0", pull-up is enabled and if selected as "1", it is disabled. PAPC is write-only register and initialized as "Fh" in reset state. The pull-up is automatically disabled, if corresponding port is selected as output.

3.1.3. PA Open Drain Assign Register (PAOD)

PA Open Drain Assign Register (PAOD) is 4-bit register, and can assign PA port as open drain output port each bit If PAOD is selected as "0", port PA is open drain output, and if selected as "1", it is push-pull output. PAOD is write-only register and initialized as "Fh" in reset state.

3.1.4. PA I/O Data Direction Register (PADD)

PA I/O Data Direction Register (PADD) is 4-bit register, and can assign input state or output state to each bit. If PADD is "0", port PA is in the input state, and if "1", it is in the output state. Since PADD is initialized as "0h" in reset state, the whole port PA becomes input state.

3.1.5. PA Stop Release Selection Register (PAST)

PA Stop Release Selection Register (PAST) is 4-bit register, and can assign stop release pin or not. If PAST is selected as "0", stop release function is enabled and if selected as "1", it is disabled. PAST is write-only register and initialized as "Fh" in reset state.

3.1.6. PA Function Selection Register (PAFL)

3.1.7. PA Function Selection Register (PAFH)

Selection Mode of PAFL

Bit Name		Selection Mode	Remarks
PA ₁	00	1/O	
	01	ADC selection	AN ₁
	10	Interrupt selection	INT1(EC1)
	11	AVREF selection	VRFF
PA ₀	00	I/O	
	01	ADC selection	AN ₀
	10	Interrupt selection	INTO(ECO)
		Tout selection	TMA

Selection Mode of PAFH

3.1.8. PA Current Driving Control Register (PACD)

PA Current Driving Control Register (PACD) is 4-bit register, and can enhance current drive capacity. If PACD is selected as "1", current driving control function is enabled and if selected as "0", it is disabled. PACD is write-only register and initialized as "0h" in reset state.

3.2. Port PB

3.2.1. PB Data Register (PB)

PB data register (PB) is 4-bit register to store data of port PB.

When set as the output state by PB, and data is written in PB, data is outputted into PB pin. When set as the input state, input state of pin is read. The initial value of PB is "Fh" in reset state. At output state, if port PB is read, PB Data Register is read instead of port PB.

3.2.2. PB Pull-up Resistor Control Register (PBPU)

PB pull-up resistor control register (PBPU) is 4-bit register and can control pull-up on or off each bit, if corresponding port is selected as input. If PBPC is selected as "0", pull-up is enabled and if selected as "1", it is disabled. PBPU is write-only register and initialized as "Fh" in reset state. The pull-up is automatically disabled, if corresponding port is selected as output.

3.2.3. PB Open Drain Assign Register (PBOD)

PB Open Drain Assign Register (PBOD) is 4-bit register, and can assign PB port as open drain output port each bit If PBOD is selected as "0", port PB is open drain output, and if selected as "1", it is push-pull output. PBOD is write-only register and initialized as "Fh" in reset state.

3.2.4. PB I/O Data Direction Register (PBDD)

PB I/O Data Direction Register (PBDD) is 4-bit register, and can assign input state or output state to each bit. If PBDD is "0", port PB is in the input state, and if "1", it is in the output state. Since PBDD is initialized as "0h" in reset state, the whole port PB becomes input state.

3.2.5. PB Stop Release Selection Register (PBST)

PB Stop Release Selection Register (PBST) is 4-bit register, and can assign stop release pin or not. If PBST is selected as "0", stop release function is enabled and if selected as "1", it is disabled. PBST is write-only register and initialized as "Fh" in reset state.

3.2.6. PB Function Selection Register (PBFL)

3.2.7. PB Function Selection Register (PBFH)

Selection Mode of PBFL

Bit Name	Selection Mode		Remarks	
PB1	00			
	01	I/O		
	10			
	11	Tout selection	PWM0	
	00			
	01			
	10			

Selection Mode of PBFH

3.2.8. PB Current Driving Control Register (PBCD)

PB Current Driving Control Register (PBCD) is 4-bit register, and can enhance current drive capacity. If PBCD is selected as "1", current driving control function is enabled and if selected as "0", it is disabled. PBCD is write-only register and initialized as "0h" in reset state.

4. Oscillation Circuit

4.1. Oscillation Circuit

Oscillation circuit is designed to be used either with a ceramic or crystal oscillator. Clock from oscillation circuit makes CPU clock via clock pulse generator, and then provide peripheral hardware clock.

There are 5 types of Oscillation circuit and they can be divided in 8 different oscillator option modes. The user can used OTP Configuration Option Bits (OSCS2 through OSCS0) to select one of these 5 types. Refer to Table 4.1.

- XT : Crystal (Ceramic) Oscillator
- LP : 32.768kHz Crystal Oscillator
- ERC : External RC Oscillator
- ECKIN : External Clock Input
- IRC : Internal RC Oscillator (4 modes)

First type is Crystal (Ceramic) oscillator circuit. OSC1 and OSC2 are the input and output, respectively, a inverting amplifier which can be set for use as an on-chip oscillator. It is designed to be used either with a ceramic resonator or crystal oscillator. In the STOP mode, oscillation stop, OSC2 state goes to "High", OSC1 state goes to "Low", and built-in feedback resistor is disabled. Second type is 32.768kHz Ceramic oscillator circuit. It operate same as the first type.

Third type is External clock input circuit. Through the OSC1, external clock is driven. Minimum and maximum high and low times specified on the data sheet must be observed. OSC2/PB2 is selectable the normal I/O port PB2. In STOP mode, OSC1 state does not go to "Low", and external clock does not affect to Internal.

Fig.4.1 Oscillator configurations

Another type is RC oscillation circuits. It can be constructed by connecting a resistor between OSC1 and VDD. It offers additional cost savings for timing insensitive applications. The RC oscillator frequency is a function of the supply voltage, the external resistor (Rext) value, and the operating temperature. The user needs to take into account variation due to tolerance of external R components used. In STOP mode, OSC1 state goes to "Hi-Z" and RC Oscillation is stopped.

The other type is Internal RC Oscillator circuit. In this type, OSC1/PB3 is used the normal I/O port PB3, OSC2/PB2 is selectable the normal I/O port PB2. The Internal Oscillator is calibrated in Factory. In STOP mode, Internal RC oscillator is stopped.

Below table shows the selection of the oscillator type by OTP Configuration Option Bits (Address 8000h, OSCS2 ~ OSCS0). (Refer to 14.2. Configuration Option Bit Description)

OSCS[2:0]					
OSCS[2]	OSCS[1]	OSCS[0]	Oscillator Modes	OSC ₁	OSC ₂
			Internal RC 4MHz	PB3 (I/O)	PB2 (I/O)
			Internal RC 8MHz		
			Internal RC 16MHz		
		0	External RC Oscillator	$OSC1$ (I)	PB2 (I/O)
0			External Clock Input	$OSC1$ (I)	PB2 (I/O)
0		O	XT Oscillator	$OSC1$ (I)	$OSC2$ (O)
O			Low Frequency Oscillator	$OSC1$ (I)	$OSC2$ (O)
			Internal RC 1MHz	PB3 (I/O)	PB2 (I/O)

Table. 4.1 Oscillator Type and Modes Selection

4.2. System Clock & Peripheral Clock Generator Block Diagram

5. Watch Dog Timer

5.1. Watch Dog Timer (WDT)

Watch dog timer is organized binary of 19 steps. The signal of $f_{OSC}/4$ cycle comes in the first step of WDT after WDT reset. If this counter was overflowed, reset signal automatically come out so that internal circuit is initialized. The overflow time is initially $2^{18} \times 4/f_{\text{OSC}}$ (262.144ms at $f_{\text{OSC}} = 4.0$ MHz), it is selectable by WDT Control Register (WDTCR). Normally, the binary counter must be reset before the overflow by using reset instruction (WDTC), Power-on reset pulse or Low VDD detection pulse. It is constantly reset in STOP and SLEEP mode. When STOP and SLEEP are released, counting is restarted.

If it's executed the STOP instruction after setting the bit RWDTEN of WDTCR to "1", the Internal RC-Ring Oscillated Watch-dog Timer (RCWDT) mode is activated.

5.1.1. WDT Control Register

Reset or Interrupt Wakeup Time (Example)

Fig.5.1 Block Diagram of Watch-dog Timer

6. Timer

6.1. Timer

6.1.1. Timer operation mode

Timer is basically made of Timer Data Register, Timer Mode Register and control circuit. The types of Timer are 12bit binary counter Timer0 (T0), 8bit binary counter Timer1 (T1).

Timer0 Data Register consists of Timer0 Data 0 High Register (T0D0H), Timer0 Data 0 Middle Register (T0D0M), Timer0 Data 0 Low Register (T0D0L), Timer0 Data 1 High Register (T0D1H), Timer0 Data 1 Middle Register (T0D1M) and Timer0 Data 1 Low Register (T0D1L).

Timer1 Data Register consists of Timer1 Data 0 High Register (T1D0H), Timer1 Data 0 Low Register (T1D0L), Timer1 Data 1 High Register (T1D1H) and Timer1 Data 1 Low Register (T1D1L).

Fig.6.1 Timer/Counter Block diagram
6.2. Timer0

6.2.1. Timer0(T0) Block Diagram

6.2.2. Timer0 Control Register

Selection Mode of T0MR0

• Timer0 Mode Register 1 (T0MR1)

Selection Mode of T0MR1

Caution : PS0/2 must be used only in the case of fosc \leq 4.0MHz

• Timer0 Mode Register 2 (T0MR2)

Selection Mode of T0MR2

• Timer0 Data0 Register Low (T0D0L) = PWM0 DUTY LSB

• Timer0 Data0 Register Middle (T0D0M) $=$ PWM0 DUTY MSB

• Timer0 Data0 Register High (T0D0H) = PWM0 DUTY EXTENSION

• Timer0 Count Register Low (T0CRL)

• Timer0 Count Register Middle (T0CRM)

• Timer0 Count Register High (T0CRH)

• Timer0 Data1 Register High (T0D1H) = PWM0 CYCLE

6.2.3. Timer0 Caution

Caution : In the case of T0EG is "0",

Want to count "0", set T0EG=1

6.2.4. TMA/TMB OUTPUT CONTROL

* TMA/TMB Logical Output Control

* TMA/TMB Output Timing Diagram

• TMA/TMB Output Control Register (TMCR)

Selection Mode of TMCR

6.2.5. Timer0 Timing Diagram

* 12-bit Timer/Counter mode Timing Diagram

Note > CS : Timer0 Counter Clear & Start.

Reload : Timer0 Data move from Data buffer to Data register.

* Start / Stop operation

* 12-bit Timer/Counter mode Timing Diagram

* 12-bit Capture mode Timing Diagram

• PWM mode Timing Diagram : (T0EG=0)

• PWM mode Timing Diagram : (T0EG=1)

• PWM mode Condition :

Cycle \neq #0 Period \neq #1 Duty < Period Duty Extension < Cycle

• PWM mode Timing Diagram : (T0EG=0, DUTY EXTENSION=0)

• PWM mode Timing Diagram : (T0EG=1, DUTY EXTENSION=0)

Duty Extension < Cycle

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• T0 OUTPUT (PWM mode) Timing Diagram : (OUTC0=0, T0EG=0, DUTY EXTENSION=0)

• T0 OUTPUT (PWM mode) Timing Diagram : (OUTC0=1, T0EG=0, DUTY EXTENSION=0)

• T0 OUTPUT (PWM mode) Timing Diagram : (OUTC0=0, T0EG=0, DUTY EXTENSION=1)

• T0 OUTPUT (PWM mode) Timing Diagram : (OUTC0=1, T0EG=0, DUTY EXTENSION=1)

6.3. Timer1

6.3.1. Timer1(T1) Block Diagram

6.3.2. Timer1 Control Register

• Timer1 Mode Register 0 (T1MR0)

Selection Mode of T1MR0

• Timer1 Mode Register 1 (T1MR1)

Selection Mode of T1MR1

6.3.3. Timer1 Caution

Caution : In the case of T1EG is "0",

Want to count "0", set T1EG=1

6.3.4. Timer1 Timing Diagram

Note > CS : Timer1 Counter Clear & Start.

Reload : Timer1 Data move from Data buffer to Data register.

* Start / Stop operation

* 8-bit Timer/Counter mode Timing Diagram

* 8-bit Capture mode Timing Diagram

• PWM mode Timing Diagram : (T1EG=0)

• PWM mode Timing Diagram : (T1EG=1)

• PWM mode Condition :

Cycle \neq #0 Period \neq #1 Duty < Period Duty Extension < Cycle

• PWM mode Timing Diagram : (T1EG=0, DUTY EXTENSION=0)

• T1 OUTPUT (PWM mode) Timing Diagram : (T1EG=0, DUTY EXTENSION=0)

• T1 OUTPUT (PWM mode) Timing Diagram : (T1EG=0, DUTY EXTENSION=1)

The ADAM43P1108 contains 8 interrupt sources; 3 externals and 5 internals. Nested interrupt services with priority control is also possible.

- ▶ 8 interrupt source (3Ext, 2Timer, 1 A/D, 1VDI, 1WDT)
- ▶ 8 interrupt vector
- ▶ 8 level nested interrupt control is possible.
- ▶ Read of interrupt request flag are possible.
- ▶ In interrupt accept, request flag is automatically cleared.

Interrupt Enable Register (IENR0, IENR1), Interrupt Request Register (IRQR0, IRQR1) and priority circuit.

Interrupt function block diagram is shown in Fig.7.1

7.1. Interrupt Source

Each interrupt vector is independent and has its own priority.

Table 7.1 Interrupt Source

7.2. Interrupt Control Register

I flag of SFR is a interrupt mask enable flag. When I flag = ` ` 0 ` `, all interrupts become disable. When I flag = $\lq i$, interrupts can be selectively enabled and disabled by contents of corresponding Interrupt Enable Register(IENR0, IENR1).

When interrupt is occurred, interrupt request flag is set,and Interrupt request is detected at the edge of interrupt signal. The accepted interrupt request flag is automatically cleared during interrupt cycle process. The interrupt request flag maintains ``1`` until the interrupt is accepted

or is cleared in program. In reset state, interrupt request flag register (IRQR0,IRQR1) is cleared to ``0``. It is possible to read the state of interrupt register and to manipulate the contents of register.

• External Interrupt Edge selection Register 0 (IEDS0)

Selection Mode of IEDS1

• Interrupt Enable Register 0 (IENR0)

Selection Mode of IENR0

• Interrupt Enable Register 1 (IENR1)

Selection Mode of IENR1

Selection Mode of IRQR0

• Interrupt Request Flag Register (IRQR1)

Selection Mode of IRQR1

7.3. Interrupt Timing

Interrupt Request Sampling Time :

- -. Maximum 2 machine cycle (When execute LDW @ABR Instruction)
- -. Minimum 0 machine cycle

Interrupt preprocess step is 1 machine cycle

7.4. The valid timing after executing Interrupt control instructions

I flag is valid just after executing of EI/DI on the contrary.

7.5. Multiple Interrupt

If there is an interrupt, Interrupt Mask Enable Flag is automatically cleared before entering the Interrupt Service Routine. After then, no interrupt is accepted. If EI instruction is executed, interrupt mask enable bit becomes "1", and each enable bit can accept interrupt request. When two or more interrupts are generated simultaneously, the highest priority interrupt is accepted.

Key-Scan or External Interrupt Enable Processing Step

7.6. Interrupt Processing Sequence

When an interrupt is accepted, the on-going process is stopped and the interrupt service routine is executed. After the interrupt service routine is completed it is necessary to restore everything to the state before the interrupt occurred.

As soon as an interrupt is accepted, the content of the program counter is saved in the stack register which is 8 level stack area, and the contents of status flag register (SFR) is saved on the interrupt stack register (INTSK) which is 8 level stack area.

At the same time, the content of the vector address corresponding to the accepted interrupt, which is in the interrupt vector table, enters into the program counter and interrupt service is executed. In order to execute the interrupt service routine, it is necessary to write the jump addresses in the vector table corresponding to each interrupt.

Interrupt Processing Step

Fig.7.2 Interrupt Processing Step Timing

The analog-to-digital (A/D) converter allows conversion of an analog input signal to a corresponding digital number. The A/D module has 5 selectable analog inputs.

The output of sample is the input into converter , which generates the result via successive approximation.

The A/D module has four register. These registers are

- A/D CONVERTER MODE REG 0.(ADCM0)
- A/D CONVERTER MODE REG 1.(ADCM1)
- A/D CONVERTER INPUT SELECTION REG 2.(ADCIS)
- A/D CONVERTER DATA REG 0.(ADCR0)
- A/D CONVERTER DATA REG 1.(ADCR1)
- A/D CONVERTER DATA REG 2.(ADCR2)

Fig.8.1 A/D Converter Block Diagram

8.1. A/D Converter Control Registers

• A/D Converter Mode Register (ADCM0)

Selection Mode of ADCM0

• A/D Converter Mode Register (ADCM1)

Selection Mode of ADCM1

• A/D Converter Input Selection Register (ADCIS)

Selection Mode of ADCIS

• A/D Converter Data Register 0 (ADCR0)

• Total Conversion Time is

 $(16 + 8*12 + 4)*$ ADCK

 $freq = 4MHz$

8.2. A/D Converter Caution

8.2.1. Noise Countermeasures of AN[7:6], AN[2:0]

It is recommend that a capacitor be connected externally as shown Fig.8.2 in order to reduce noise.

Fig.8.2 Analog input pin Connecting capacitor

8.2.2. VREF pin input impedance

A series resistor string of approximately 100 k $\Omega \sim 150$ k Ω is connected between VREF pin and VSS.

If the output impedance of VREF is high, it will result in parallel connection to the series resistor between VREF pin and GND, and there will be a large reference voltage error.

8.3. A/D Converter Operation Flow

9. Power-Down Function

In power-down mode, power consumption is reduced considerably that in battery operation battery life time can be extended a lot. For applications where power consumption is a critical factor, ADAM43P1108 provides two kinds of power-down functions, STOP mode and SLEEP mode. In this 2 Modes, program processing is stopped.

9.1. Stop Mode

STOP mode can be entered by STOP instruction during program. In STOP mode, oscillator is stopped to make all clocks stop, which leads to less power consumption. All registers and RAM data are preserved. ″NOP″ instruction should be follows STOP instruction for pre-charge time of Data Bus line.

> ex) STOP : STOP instruction execution NOP : NOP instruction

Additionally, if it's executed the STOP instruction after setting the bit RCWDTEN of WDTCR to "1", the Internal RC-Oscillated Watchdog Timer mode is activated. In the Internal RC-Oscillated Watchdog Timer mode, STOP mode is also released by occurring of WDT Time-out selected by WDTCK[1:0].

The Ring-OSC oscillation period is vary with temperature, VDD and process variations from part to part. According to the bit RCWDTCK of WDTCR, the RCWDT oscillated watchdog timer time-out is shown at Chapter 5. Watch Dog Timer.

″NOP″ instruction should be follows STOP instruction for pre-charge time of Data Bus line.

ex) LRI WDTCR, #0100b : set the bit of RCWDTEN WDTC : WDT clear STOP : STOP instruction execution

NOP : NOP instruction NOP : NOP instruction

9.1.1. Stop Mode Release

Release of STOP mode is executed by Power on reset , Key input Port(one of PA, PB) which is selected by PAST and PBST register for stop release makes the edge selected by IEDS1[1:0], external interrupt and Low voltage detection (LVD) mode release .

When there is a release signal of STOP mode, the instruction execution starts after stabilization oscillation time.(2^{14} ×4/fOSC = 16.384ms at fOSC = 4.0MHz)

9. Power-Down Function

9.2. Sleep Mode

SLEEP mode can be entered by SLEEP instruction during program. In SLEEP mode, basically CPU and ROM halts while oscillation and peripherals are operate. ″NOP″ instruction should be follows SLEEP instruction for pre-charge time of Data Bus line.

> ex) SLEEP : SLEEP instruction execution NOP : NOP instruction

9.2.1 Sleep Mode Release

Release of SLEEP mode is executed by Power on reset, all interrupts and Low voltage detection (LVD) mode release. To be release by interrupt, interrupt should be enabled before SLEEP mode. This mode don't need the stabilization oscillation time.

9.3. Operation States in Stop/Sleep Mode

Table 9.1 Operation States in Stop Mode and Sleep Mode

10. RESET Function

10.1. Power On RESET

Power On Reset circuit automatically detects the rise of power voltage

(the rising time should be within 50ms). Until the power voltage reaches a certain voltage level, internal reset signal is maintained at ″L″ Level until oscillator is stable.

After power applies, this reset state is maintained for the configuration option reading time (about 7.2ms at VDD=5.0V) and the oscillation stabilization time. (4/fosc x 57 x 2^{10} = about 58.368ms at 4MHz).

Fig.10.2 Oscillator stabilization diagram

Notice. When Power On Reset, oscillator stabilization time doesn't include OSC. Start time.

11. Low Voltage Detection Mode

11.1. Low Voltage Detection Condition

An on board voltage comparator checks that V_{DD} is at the required level to ensure correct operation of the device.

If V_{DD} is below a certain level, Low voltage detector forces the device into low voltage detection mode.

11.2. Low Voltage Detection Mode

There is no power consumption except stop current.

- 1. STOP mode release function is disabled.
- 2. I/O port is configured as input mode (without pull-up resistor).
- 3. Data memory is retained until voltage through external capacitor is worn out.
- 4. Interrupt disabled.
- 5. Oscillator is stop.

11.3. Release of Low Voltage Detection Mode

Reset signal result from new battery or any other power (normally 3V/5V) wakes the low voltage detection mode and come into normal reset state. It depends on user whether to execute RAM clear routine or not.

11.4. Low Voltage Detection voltage selection (option)

User can select the voltage of Low Voltage detection voltage level by OTP Configuration Bits (LVDS). One is high voltage version (typ. 2.2V, if LVDS is "0"), another is low voltage version (typ. 1.7V, if LVDS is "1").

12. Voltage Detection Indicator Mode

12.1. Voltage Detection Indicator Register

Voltage Detection indicator (VDI) are controlled by two registers. It is useful to display the consumption of Batteries.

If VDD power level is low and higher than low voltage detection (LVD) level (refer to Fig.13.1), the bit of VDIR register could be set according to the VDD level sequentially.

The VDD detection levels for Indication are three , that is , VDIR2 (Typ. 4.0V) , VDIR1(Typ. 3.0V) and VDIR0 (Typ. 2.5V) of VDIR register.

12.1.1. Voltage Detection Indicator Enable Register (VDIER)

Voltage Detection Indicator Enable Register (VDIER) is 4-bit register, and can assign Indicator is enable or not.

If VDIER2 \sim VDIER0 is selected as "0", Voltage detection for Indication function is disabled and if selected as "1", it is enable. If VDIM is selected as "0" and enable one of VDIER2~VDIER0, when the corresponding voltage detection for Indication is occurred, it makes the system reset. If LVIM is selected as "1", it makes the VDI interrupt.

VDIER is write-only register and initialized as ``0 h`` in reset state.

In the in-circuit emulator, VDI function is not implemented and user can not experiment with it. Therefore after final development of user program, this function may be experimented or evaluated.

12.1.2. Voltage Detection Indicator Data Register (VDIR)

Voltage Detection Indicator Data Register (VDIR) is 3-bit register to store data of low voltage level. VDIR is read only register and initialized as "0h" in reset state.
12. Voltage Detection Indicator Mode

12.2. Timming Diagram

13. SRAM Data Back-Up

13.1 SRAM DATA BACK-UP after Low Voltage Detection

Fig.13.1 Low Voltage Detection and Protection

13.2. S/W flow chart example after Reset using SRAM DATA Back-up

14. MTP Programming

14.1. MTP Writing Pin Assignments

14.2. Configuration Option Bit Description

15.1. Legend

- r : peripheral address register(6bit)
- [r] : data addressed by peripheral address register (4bit)
- Y : Y register(4bit)
- X : X register(4bit)
- ABR : address buffer register(15bit)
- ABRn : address buffer register #0~3(4bit)
- [@ABR] : data addressed by ABR(16bit)
- DBR : data buffer register(16bit)
- DBRn : data buffer register #0~3(4bit)
- T0CR : Timer 0 count register(8bit)
- T1CR : Timer 1 count register(8bit)
- #n4 : 0~Fh
- #n2 : 0~3
- $\#n1$: 0~1
- dp : data address point(8bit)
- dp+X+Y : data address point indexed by X-register and Y-register (8bit)
- PG : page address(1bit)
- ADS : address stack register
- !abs : address

15.2. Instruction Set Table

**[Note] The Instruction "LDW @ABR" execution time is 2cycle and execution process is as follow.

 $SP = SP-1$, $ADS \leftarrow PG+PC$,

 $PG+PC \leftarrow ABR$, DBR \leftarrow (PG+PC), PG+PC \leftarrow ADS, SP = SP+1

** CARRY BIT(CY) hold previous value before execution CLRC/SETC instruction .

Symbols have meaning as follows.

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O : Carry bit is only set when overflow has occurred in operation.

W : Carry bit is only set when borrow has occurred in operation.

 \vert R : Carry bit is only set or reset according to shift bit.

** STATUS BIT(S) indicates conditions for changing status. Symbols have meaning as follows.

S : On executing an instruction, status bit is unconditionally set.

C : Status bit is only set when overflow has occurred in operation.

B : Status bit is only set when underflow has not occurred in operation.

E : Status bit is only set when equality is found in comparison.

N : Status bit is only set when equality is not found in comparison.

Z : Status bit only set when the result is zero.

T : Status bit only set when the carry has occurred in operation.